

## QUICKSWITCH® PRODUCTS HIGH-SPEED CMOS 10-BIT LOW RESISTANCE BUS SWITCH WITH ACTIVE HIGH AND LOW ENABLES

## FEATURES:

- Enhanced N channel FET with no inherent diode to Vcc
- 2.5 $\Omega$  bidirectional switches connect inputs to outputs
- Zero propagation delay, zero ground bounce
- Undershoot clamp diodes on all switch and control pins
- Available in SOIC and QSOP Packages
- Active Low and High enable controls
- Bidirectional signal flow

### APPLICATIONS

- Hot-swapping and hot-docking (low RON resistance for PCI and Compact PCI applications)
- Voltage translation (5V to 3.3V)
- Power conservation
- Capacitance reduction and isolation
- Applications requiring Low RON resistance and active High enabling
- Bus isolation
- Clock gating

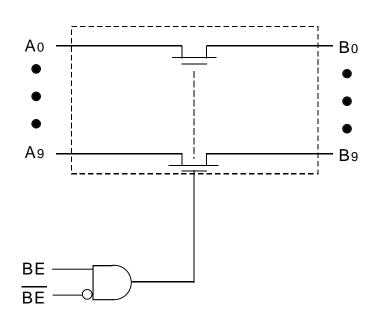
## **FUNCTIONAL BLOCK DIAGRAM**

#### **DESCRIPTION:**

The QS3R862 provides a set of ten high-speed CMOS TTL-compatible bus switches. The very low ON resistance  $(2.5\Omega)$  of the QS3R862 allows inputs to be connected to outputs without adding propagation delay and without generating additional ground bounce noise. The switches are controlled by active Low Enable (BE) and active High Enable (BE) controls.

The QS3R862 with  $2.5\Omega$  Row resistance is ideal for switching digital buses as well as for hot-plugging, hot-swapping, and hot-docking applications. The low Row resistance of the QS3R862 makes it ideal for PCI, Compact PCI, and VME hot-plugging applications.

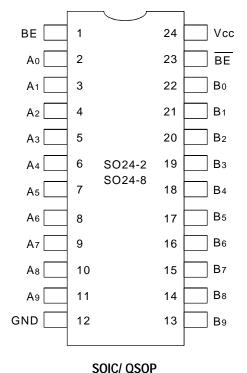
The QS3R862 is characterized for operation at -40°C to +85°C.



#### INDUSTRIAL TEMPERATURE RANGE

#### **NOVEMBER 1999**

#### **PIN CONFIGURATION**



TOP VIEW

## ABSOLUTE MAXIMUM RATINGS (1)

Symbol	Description Max.		Unit
VTERM <sup>(2)</sup>	Supply Voltage to Ground	– 0.5 to +7	V
VTERM <sup>(3)</sup>	DC Switch Voltage Vs	– 0.5 to +7	V
VTERM <sup>(3)</sup>	DC Input Voltage VIN	– 0.5 to +7	V
VAC	AC Input Voltage (pulse width ≤20ns)	-3	V
Ιουτ	DC Output Current	120	mA
Рмах	Maximum Power Dissipation	.5	W
Tstg	Storage Temperature	– 65 to +150	°C

#### NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. Vcc Terminals.
- 3. All terminals except Vcc.

#### CAPACITANCE

 $(T_A = +25^{\circ}C, f = 1.0MHz, V_{IN} = 0V, V_{OUT} = 0V)$ 

Pins	Тур.	Max. <sup>(1)</sup>	Unit
Control Inputs	3	4	pF
Quickswitch Channels (Switch OFF)	5	6	pF

NOTE:

1. This parameter is guaranteed but not production tested.

#### **PIN DESCRIPTION**

Pin Names	I/O	Description
BE	Ι	Active LOW Bus Enable
BE	I	Active HIGH Bus Enable
A0 - A9	I/O	Bus A
B0 - B9	I/O	Bus B

#### **FUNCTION TABLE(1)**

BE	BE	A0 - A9	Function	
L	L	Hi-Z	Disconnect	
L	Н	Hi-Z	Disconnect	
Н	L	B0 - B9	Connect	
Н	Н	Hi-Z	Disconnect	

#### NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

Z = High-Impedence

# DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40°C to +85°C, Vcc =  $5.0V \pm 10\%$ 

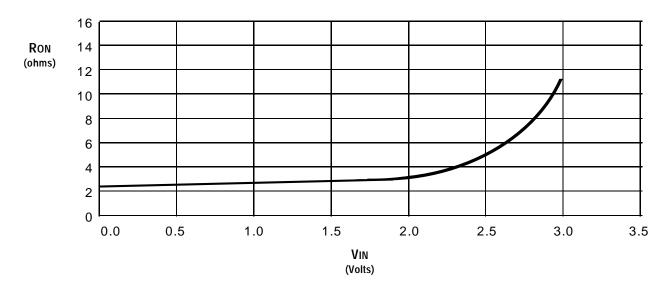
Symbol	Parameter	Test Conditions	Min.	Тур. <sup>(1)</sup>	Max.	Unit
Vih	Input HIGH Voltage	Guaranteed Logic HIGH for Control Pins	2	_	-	V
VIL	Input LOW Voltage	Guaranteed Logic LOW for Control Pins	-	—	0.8	V
lin	Input Leakage Current (Control Inputs)	$0V \le VIN \le Vcc$	-	±0.01	±1	μA
loz	Off-State Current (Hi-Z)	$0V \le VOUT \le Vcc$ , Switches OFF	_	±0.01	±1	μA
Ron	Switch ON Resistance	Vcc = Min., VIN = 0V, ION = 30mA	-	2.5	5	Ω
Ron	Switch ON Resistance	Vcc = Min., VIN = 2.4V, ION = 15mA	_	4	8.5	Ω
Vp	Pass Voltage <sup>(2)</sup>	$VIN = Vcc = 5V$ , $IOUT = -5\mu A$	3.7	4	4.3	V

NOTES:

1. Typical values are at Vcc = 5.0V, TA =  $25^{\circ}C$ .

2. Pass voltage is guaranteed but not production tested.

## **TYPICAL ON RESISTANCE vs Vin AT Vcc = 5V**



## **POWER SUPPLY CHARACTERISTICS**

S	ymbol	Parameter	Test Conditions <sup>(1)</sup>	Typ. <sup>(2)</sup>	Max.	Unit
Ic	CO	Quiescent Power Supply Current	$V_{CC} = Max., V_{IN} = GND \text{ or } V_{CC}, f = 0$	0.2	3	μA
Δ	lcc	Power Supply Current per Control Input HIGH	$V_{CC} = Max., V_{IN} = 3.4V^{(3)}, f = 0$	_	2.5	mA
Ic	CCD	Dynamic Power Supply Current per MHz <sup>(4)</sup>	Vcc = Max., A and B pins open	_	0.25	mA/MHz
			BE or BE Inputs Toggling at 50% Duty Cycle			

#### NOTES:

1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.

2. Typical values are at Vcc = 5.0V, TA =  $25^{\circ}C$ .

3. Per TLL driven input (VIN = 3.4V, control inputs only). A and B pins do not contribute to  $\Delta$ Icc.

4. This current applies to the control inputs only and represents the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is guaranteed but not production tested.

# SWITCHING CHARACTERISTICS OVER OPERATING RANGE

 $TA = -40^{\circ}C \text{ to } +85^{\circ}C, Vcc = 5.0V \pm 10\%$ 

#### CLOAD = 50pF, RLOAD = 500 $\Omega$ unless otherwise noted.

Symbol	Parameter	Min. <sup>(1)</sup>	Тур.	Max.	Unit
<b>t</b> PLH	Data Propagation Delay <sup>(2,4)</sup>			0.12 <sup>(3)</sup>	
<b>t</b> PHL	A to B or B to A	—		0.12 (%)	ns
tpzl	Switch Turn-on Delay	1 6		E 4	
<b>t</b> PZH	BE or BE to A or B	1.5	l.	5.6	ns
tPLZ	Switch Turn-off Delay <sup>(2)</sup>	1 6		4 6	
<b>t</b> PHZ	BE or BE to A or B	1.5		4.5	ns

#### NOTES:

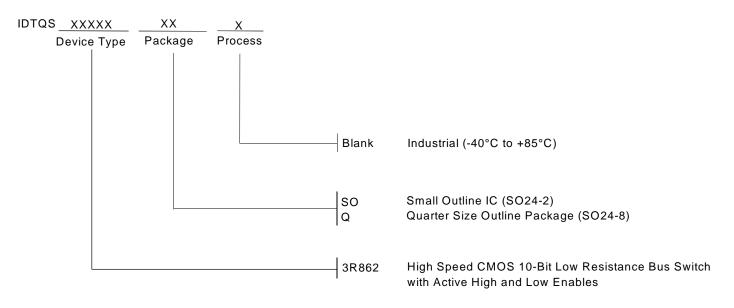
1. Minimums are guaranteed but not production tested.

2. This parameter is guaranteed but not production tested.

3. The time constant for the switch alone is of the order of 0.12ns for CL = 50 pF.

4. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

#### **ORDERING INFORMATION**





*CORPORATE HEADQUARTERS* 2975 Stender Way Santa Clara, CA 95054 for SALES: 800-345-7015 or 408-727-6116 fax: 408-492-8674 www.idt.com\*

\*To search for sales office near you, please click the sales button found on our home page or dial the 800# above and press 2. The IDT logo, QuickSwitch, and SynchroSwitch are registered trademarks of Integrated Device Technology, Inc.